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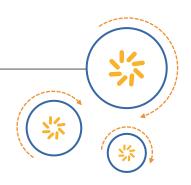






RF360 Europe GmbH

A Qualcomm - TDK Joint Venture



SAW Components

SAW resonator

Short range devices

Series/type: R972

Ordering code: B39391R 972H110

Date: August 26, 2014

Version: 2.1

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SAW Components

R972

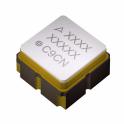
SAW resonator 390.00 MHz

Data sheet



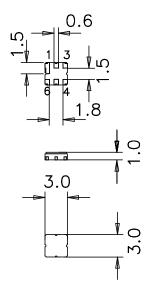
Application

- 1-port resonator
- Provides reliable, fundamental mode, quartz frequency stabilization i.e. in transmitters or local oscillators



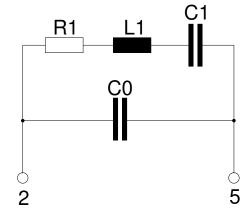
Features

- Package size 3.0 x 3.0 x 1.0 mm³
- Package code DCC6E
- RoHS compatible
- Approximate weight 0.037 g
- Package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Lead free soldering compatible with J STD20C
- Passivation layer Elpas
- AEC-Q200 qualified component family
- Electrostatic Sensitive Device (ESD)



Pin configuration

- 2 Input
- Output, grounded in 1-port conf.
- 1, 3, 4, 6 Ground (case)





SAW Components

SAW resonator

390.00 MHz

Data sheet

SMD

Characteristics

 $\begin{array}{ll} T_A &= 25 \ ^\circ C \\ Z_S &= 50 \ \Omega \\ Z_L &= 50 \ \Omega \end{array}$ Reference temperature: Terminating source impedance: Terminating load impedance:

		min.	typ.	max.	
Center frequency ¹⁾	f _C	389.950	390.00	390.050	MHz
Minimum insertion attenuation	α_{min}	_	1.3	1.7	dB
Unloaded quality factor	Q_U	4500	6600	_	
Ageing of f _C		_	_	-50/+50	ppm
Equivalent circuit elements					
Motional capacitance	C_1	_	2.693	_	fF
Motional inductance	L_1	_	61.86	_	μН
Motional resistance	R_1	_	19	27	Ω
Parallel capacitance ²⁾	C_0	_	3.9	_	pF
Temperature coefficient of frequency ³⁾	TC _f	_	-0.032	_	ppm/K ²
Turnover temperature	T_0	10	_	30	°C

Maximum ratings

Operable temperature range	T	-45/+125	°C
Storage temperature range	T_{stg}	-45/+125	°C
DC voltage	V_{DC}	12	V
Source power	P_S	0	dBm

 $^{^{1)}}$ Center frequency is defined as maximum of the real part of the admittance. $^{2)}$ If used in two port configuration (pin 2 - input, pin 5 - output) C_0 is reduced by approx. 0.3 pF. $^{3)}$ Temperature dependence of f_C : $f_C(T_A) = f_C(T_0) \ (1 + TC_f \ (T_A - T_0)^2)$



SAW Components	R972
SAW resonator	390.00 MHz

Data sheet



References

Туре	R972
Ordering code	B39391R 972H110
Marking and package	C61157-A7-A143
Packaging	F61074-V8228-Z000
Date codes	L_1126
Soldering profile	S_6001
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.
Coils	See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm

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